

SOLVCLEAN

**DEGREASER
FOR SURFACE PREPARATION**



7 good reasons for using SOLVCLEAN

1. Powerful **degreaser**.
2. Removes excess **glues and resins**.
3. **Quick drying** of cleaned surfaces.
4. Leaves no **residue** after evaporation.
5. Contains **no** chlorinated hydrocarbon.
6. **Non-corrosive** on metals.
7. Flash point of **28°C**.

Particularly suitable for use in



Industry



Construction



Services

For operations including the reactivation of primers.
For the preparation of surfaces for painting or glueing (aluminium, light alloys, steel, composite).
For cleaning printing ink, flexography, on machine frameworks.
For the removal glue or putty residues.
For surface degreasing by wiping.
Asbestos disposal: for cleaning traces of adhesives on equipment (extractors, sluices, etc...).

Characteristics	WYPNET	Instructions for use
Composition : mixture of oxygenated solvents Flash point: 28°C Density: 0.90 For more information, see MSDS.		Always use neat. For degreasing of surfaces, apply evenly with a cloth or a brush on the surface to be treated. To removal glue, proceed by wiping.

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**7 +
CLEANSOLV** : Solvented wipes

This datasheet supersedes previous documents. The information contained in these data sheets is based on our present knowledge and experience and is given as indication only. Under no circumstances does it engage our responsibility in the event of misuse of our products. Non-contractual photos and images.



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